



SLLS562A - MARCH 2003 - REVISED - MARCH 2003

LOW-POWER RS-485 TRANSCEIVER

FEATURES

- Meets or Exceeds the Requirements of the TIA/EIA-485A Standard
- Low Quiescent Power
 - < 0.3 mA Active Mode
 - 1 nA Shutdown Mode
- Driver Outputs Optimized for Low EMI at Signaling Rates up to 200 kbps
- 1/8 Unit Load—Up to 256 Nodes on a Bus
- Bus-Pin ESD Protection Exceeds 16 kV
- Industry-Standard SN75176 Footprint
- Failsafe Receiver (Bus Open, Bus Shorted, Bus Idle)

APPLICATIONS

- Energy Meter Networks
- Power Inverters
- Industrial Automation
- Building Automation Networks
- Industrial Process Control
- Battery-Powered Applications
- Telecommunications Equipment



DESCRIPTION

This device is a half-duplex transceiver designed for RS-485 data bus networks. Powered by a 5-V supply, it is fully compliant with the TIA/EIA-485A standard. With controlled output transition times, this device is suitable for signaling rates up to 200 kbps over long twisted-pair cables. The device is designed to operate with very low supply current, typically less than 0.6 mA, exclusive of the load. When in the inactive shutdown mode, the supply current drops to a few nanoamps, making these devices ideal for power-sensitive applications.

The wide common-mode range and high ESD protection levels of these devices make them suitable for demanding applications such as energy meter networks, electrical inverters, status/command signals across telecom racks, cabled chassis interconnects, and industrial automation networks where noise tolerance is essential. The SN65HVD3082E and SN75HVD3082E match the industry-standard footprint of the SN75176. Power-on reset circuits keep the outputs in a high-impedence state until the supply voltage has stabilized. A thermal shutdown function protects the device from damage due to system fault conditions.

FUNCTIONAL DIAGRAM (POSITIVE LOGIC)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

TA	PLASTIC DUAL-IN-LINE	PLASTIC SMALL OUTLINE [†]
0°C to 70°C	SN75HVD3082EP Marked as 75HVD3082	SN75HVD3082ED Marked as VN3082
–40°C to 85°C	SN65HVD3082EP Marked as 65HVD3082	SN65HVD3082ED Marked as VP3082

(1) The D package is available taped and reeled. Add an R suffix to the device type (i.e., SN65HVD3082EDR).

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted (1) (2)

			UNITS
Supply voltage range, VC	С		–0.5 V to 7 V
Voltage range at A or B	oltage range at A or B		
Voltage range at any logic	pin	-0.3 V to V _{CC} + 0.3 V	
Continuous total power dissipation		Refer to Package Dissipation Table	
	Due terrele et al OND	HBM(3)	±16 kV
Electrostaticdischarge	Bus terminals and GND	All pins	4 kV
	Charged-DeviceModel ⁽⁴⁾ all pins		1 kV
Voltage input range, transient pulse, A and B, through 100 Ω (see Figure 13)		–50 V to 50 V	
Storage temperature range	е	–65°C to 120°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.

(3) Tested in accordance with JEDEC Standard 22, Test Method A114-A

(4) Tested in accordance with JEDEC Standard 22, Test Method C101.

RECOMMENDED OPERATING CONDITIONS(1)

		MIN	MAX	UNIT
Supply voltage, V _{CC}		4.5	5.5	V
Input voltage at any bus terminal (se	parately or common mode), VI	-7	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
High-level input voltage (D, DE, or R	el input voltage (D, DE, or RE inputs), VIH 2 V _{CC} el input voltage (D, DE, or RE inputs), VIL 0 0.8		V	
Low-level input voltage (D, DE, or RE inputs), VIL		0	0.8	V
Differential input voltage, VID		-12	12	V
	Driver	-60	60	
Output current, IO	Receiver	-8	8	mA
	SN65HVD3082E	-40	85	
Operating free-air temperature, TA	SN75HVD3082E	0	70	°C

(1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum, is used in this data sheet.



PACKAGE DISSIPATION RATINGS

PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
D	710 mW	5.7 mW/°C	455 mW	369 mW
Р	1000 mW	8.0 mW/°C	640 mW	520 mW

FUNCTION TABLE

	DRI	VER		RECEIVER		
INPUT	ENABLE	OUTPUTS	OUTPUTS	DIFFERENTIAL INPUTS	ENABLE	OUTPUT
D	DE	Α	В	B V _{ID} = V _A - V _B	RE	R
н	Н	н	L	$V_{ID} \leq -0.2 V$	L	L
L	Н	L	Н	–0.2 V < V _{ID} < –0.01 V	L	?
Х	L	Z	Z	$-0.01 \text{ V} \le \text{V}_{\text{ID}}$	L	Н
Open	Н	н	L	Х	н	Z
Х	Open	Z	Z	Open circuit	L	Н
				Short circuit	L	Н
				Х	Open	Z

NOTE: H= high level; L = low level; Z = high impedance; X = irrelevant; ? = indeterminate

PIN ASSIGNMENTS



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EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



SUPPLY CURRENT

over recommended operating conditions unless otherwise noted

	PARAMETER	TEST CONDITIONS		MIN	TYP (1)	MAX	UNIT
lcc	Driver and receiver enabled	D at 0 or V _{CC} or open, No load	DE at V _{CC} , RE at 0 V,		425	900	μΑ
	Driver enabled, receiver disabled	D at 0 or V _{CC} or open, No load	DE at V _{CC} , RE at V _{CC}		330	600	μΑ
	Receiver enabled, driver disabled	D at 0 or V _{CC} or open, No load	DE at 0 V, RE at 0 V,		300	600	μΑ
	Driver and receiver disabled	D at V _{CC} or open,	DE at 0 V, RE at V $_{CC}$		0.001	2	μΑ

(1) All typical values are at 25° C and with a 5-V supply.

DRIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions unless otherwise noted

	PARAMETER	TEST CONDITIONS	MIN	TYP (1)	MAX	UNIT
	+	I _O = 0, No load	3	4.3		
NOD		$R_L = 54 \Omega$, See Figure 1	1.5	2.3		v
NOD I	Direfential output voltage	$V_{TEST} = -7 V$ to 12 V, See Figure 2	1.5			v
Δ V _{OD} I	Change in magnitude of differential output voltage	See Figure 1 and Figure 2	-0.2	0	0.2	V
V _{OC(SS)}	Steady-state common-mode output voltage		1	2.6	3	
ΔVOC(SS)	Change in steady-state common-mode output voltage	See Figure 3	-0.1	0	0.1	V
VOC(PP)		See Figure 3		500		mV
IOZ	High-impedance output current	See receiver input currents				
lj	Input current	D, DE	-100		100	μA
IOS	Short-circuit output current	$-7 \text{ V} \le \text{V}_0 \le 12 \text{ V}$, See Figure 7	-250		250	mA

(1) All typical values are at 25° C and with a 5-supply.

DRIVER SWITCHING CHARACTERISTICS

over recommended operating conditions unless otherwise noted

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low-to-high-level output			0.7	1.3	
^t PHL	Propagation delay time, high-to-low-level output	R _L = 54 Ω, C _L = 50 pF, See Figure 4		0.7	1.3	
t _r	Differential output signal rise time		0.5	0.9	1.5	μs
t _f	Differential output signal fall time		0.5	0.9	1.5	
^t sk(p)	Pulse skew (tpHL - tpLH)			0.02	0.2	
^t PZH	Propagation delay time, high-impedance-to-high-level output	R _L = 110 Ω,		3	7	
^t PHZ	Propagation delay time, high-level-to-high-impedance output	RE at 0 V, See Figure 5		0.07	0.2	μs
^t PZL	Propagation delay time, high-impedance-to-low-level output	R _L = 110 Ω, RE at 0 V		2	7	
^t PLZ	Propagation delay time, low-level-to-high-impedance output	See Figure 6		0.09	0.2	μs
^t PZH(SHDN)	Propagation delay time, shutdown-to-high-level output	$R_L = 110 \Omega$, \overline{RE} at V_{CC} , See Figure 5		4	7	μs
^t PZL(SHDN)	Propagation delay time, shutdown-to-low-level output	$R_L = 110 \Omega$, \overline{RE} at V _{CC} , See Figure 6		3	7	μs

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RECEIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions unless otherwise noted

	PARAMETER	7	TEST CONDITIONS	MIN	TYP (1)	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage	IO = -8 mA			-85	-10	mV
VIT-	Negative-going input threshold voltage	IO = 8 mA		-200	-115		mV
V _{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)				30		mV
VOH	High-level output voltage	$V_{ID} = 200 \text{ mV}, I_{OH}$	$V_{ID} = 200 \text{ mV}, I_{OH} = -8 \text{ mA}, \text{See Figure 8}$		4.6		V
VOL	Low-level output voltage	V _{ID} = -200 mV, I _{OH} = 8 mA, See Figure 8			0.15	0.4	V
loz	High-impedance-state output current	$V_{O} = 0$ to V_{CC}		-1		1	μA
		Other input at 0 V	V _{IH} = 12 V, V _{CC} = 5 V		0.04	0.1	
	Dustinguit		$V_{IH} = 12 V, V_{CC} = 0$		0.06	0.125	
II	Bus input current		$V_{IH} = -7 V, V_{CC} = 5 V$	-0.1	-0.04		mA
			$V_{IH} = -7 V, V_{CC} = 0$	-0.05	-0.03		
Iн	High-level input current (RE)	V _{IH} = 2 V		-60	-30		μΑ
١ _L	Low-level input current (RE)	V _{IL} = 0.8 V		-60	-30		μA
Cdiff	Differential input capacitance	$V_{I} = 0.4 \sin (4E6\pi t)$	+ 0.5 V, DE at 0 V		7		pF

(1) All typical values are at 25°C and with a 5-V supply.

RECEIVER SWITCHING CHARACTERISTICS

over recommended operating conditions unless otherwise noted

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low-to-high-level output			75	200	
^t PHL	Propagation delay time, high-to-low-level output			79	200	ns
^t sk(p)	Pulse skew(tpHL-tpLH)	$V_{ID} = -1.5 V \text{ to } 1.5 V,$ - C _L = 15 pF, See Figure 9		4	30	
t _r	Output signal rise time			1.5	3	
tf	Output signal fall time			1.8	3	ns
^t PZH	Output enable time to high level	 CL = 15 pF, DE at 3 V,		5	50	
^t PZL	Output enable time to low level			10	50	
^t PHZ	Output enable time from high level	See Figure 10 and Figure 11		5	50	ns
^t PLZ	Output enable time from low level			8	50	
^t PZH(SHDN)	Propagation delay time, shutdown-to-high-level output	$C_{L} = 15 \text{pF}, DE \text{ at } 0 \text{V},$		1.6	3.5	
^t PZL(SHDN)	Propagation delay time, shutdown-to-low-level output	See Figure 12		1.7	3.5	μs

PARAMETER MEASUREMENT INFORMATION



Figure 1. Driver Test Circuit, $V_{\mbox{OD}}$ and $V_{\mbox{OC}}$ Without Common-Mode Loading







Figure 3. Driver V_{OC} Test Circuit and Waveforms



Figure 4. Driver Switching Test Circuit and Waveforms





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Figure 8. Receiver Parameter Definitions



Figure 9. Receiver Switching Test Circuit and Waveforms



Figure 10. Receiver Enable/Disable Test Circuit and Waveforms, Data Output High









Figure 12. Receiver Enable From Shutdown Test Circuit and Waveforms



Figure 13. Test Circuit and Waveforms, Transient Over-Voltage Test



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TYPICAL CHARACTERISTICS



APPLICATION INFORMATION



NOTE: The line should be terminated at both ends with its characteristic impedance ($R_T = Z_O$). Stub lengths off the main line should be kept as short as possible.

Figure 18. Typical Application Circuit

POWER USAGE IN AN RS-485 TRANSCEIVER

Power consumption is a concern in many applications. Power supply current is delivered to the bus load as well as to the transceiver circuitry. For a typical RS-485 bus configuration, the load that an active driver must drive consists of all of the receiving nodes, plus the termination resistors at each end of the bus.

The load presented by the receiving nodes depends on the input impedance of the receiver. The TIA/EIA-485-A standard defines a unit load as allowing up to 1 mA. With up to 32 unit loads allowed on the bus, the total current supplied to all receivers can be as high as 32 mA. The HVD3082E is rated as a 1/8 unit load device. As shown in Figure 14, the bus input current is less than 1/8 mA, allowing up to 256 nodes on a single bus.

The current in the termination resistors depends on the differential bus voltage. The standard requires active drivers to produce at least 1.5 V of differential signal. For a bus terminated with one standard 120- Ω resistor at each end, this sums to 25 mA differential output current whenever the bus is active. Typically the HVD3082E can drive more than 25 mA to a 60 Ω load, resulting in a differential output voltage higher than the minimum required by the standard. (See Figure 16.)

Overall, the total load current can be 60 mA to a loaded RS-485 bus. This is in addition to the current required by the transceiver itself; the HVD3082E circuitry requires only about 0.4 mA with both driver and receiver enabled, and only 0.3 mA with either the driver enabled or with the receiver enabled. In low-power shutdown mode, neither the driver nor receiver is active, and the supply current is very low.

Supply current increases with signaling rate primarily due to the totum pole outputs of the driver (see Figure 15). When these outputs change state, there is a moment when both the high-side and low-side output transistors are conducting and this creates a short spike in the supply current. As the frequency of state changes increases, more power is used.

LOW-POWER SHUTDOWN MODE

When both the driver and receiver are disabled (DE low and \overline{RE} high) the device is in shutdown mode. If the enable inputs are in this state for less than 60 ns, the device does not enter shutdown mode. This guards against inadvertently entering shutdown mode during driver/receiver enabling. Only when the enable inputs are held in this state for 300 ns or more, the device is assured to be in shutdown mode. In this low-power shutdown mode, most internal circuitry is powered down, and the supply current is typically 1 nA. When either the driver or the receiver is re-enabled, the internal circuitry becomes active.

If only the driver is re-enabled (DE transitions to high) the driver outputs are driven according to the D input after the enable times given by $t_{PZH(SHDN)}$ and $t_{PZL(SHDN)}$ in the driver switching characteristics. If the D input is open when the driver is enabled, the driver outputs defaults to A high and B low, in accordance with the driver failsafe feature.

If only the receiver is re-enabled (\overline{RE} transitions to low) the receiver output is driven according to the state of the bus inputs (A and B) after the enable times given by $t_{PZH(SHDN)}$ and $t_{PZL(SHDN)}$ in the receiver switching characteristics. If there is no valid state on the bus the receiver responds as described in the failsafe operation section.

If both the receiver and driver are re-enabled simultaneously, the receiver output is driven according to the state of the bus inputs (A and B) and the driver output is driven according to the D input. Note that the state of the active driver affects the inputs to the receiver. Therefore, the receiver outputs are valid as soon as the driver outputs are valid.

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MECHANICAL DATA

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012

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MECHANICAL DATA

P (R-PDIP-T8)

EXAS

STRUMENTS

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PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

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